

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	32	anti near2 solder near2 coating	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 10:02
L2	0	(anti near2 solder near2 coating) with component	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 10:02
L3	18	(anti near2 solder near2 coating) and component	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 10:03
L4	6	("4559514").URPN.	USPAT	OR	ON	2005/08/26 10:21
L5	46	(("5371971") or ("5973337") or ("6381838") or ("5371328") or ("5862697") or ("5969461") or ("4030948") or ("5579573") or ("6299056") or ("3882083") or ("4599272") or ("5639989") or ("5855994") or ("5891969") or ("5895228") or ("5925893") or ("6262513") or ("6337381") or ("5337398") or ("5314513") or ("5039735") or ("5784258")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/08/26 10:27
L6	9	("3911431" "3964296" "4315225" "4841414" "5265792" "5475241" "5654228" "5882949" "6174753").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/26 10:34
L7	4	("4364017" "4734608" "5010270" "5243250").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/26 10:34

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	anti adj solder adj coating	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:07
L2	32	anti near2 solder near2 coating	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:08
L3	0	2 and hydrous	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:15
L4	0	2 and (stamping or dipping)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:12
L5	26	2 and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:09
L6	1	2 and (stamping or dipping or roller or sponge or spraying)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:29
L7	153	hydrous adj solution	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:15
L8	39	7 and coating	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:15
L9	0	7 and coating and solder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:15

L10	27	7 and coating and component	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:16
L11	3	("4511218").URPN	USPAT	OR	ON	2005/08/26 16:29
L12	5626	(LED adj chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:29
L13	1151	(LED adj chip) and coating	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:29
L14	0	(LED adj chip) and coating and hydrous	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:29
L15	215	13 and (stamping or dipping or roller or sponge or spraying)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:31
L16	2105	(plastic adj component) and (stamping or dipping or roller or sponge or spraying)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:31
L17	804	(plastic adj component) and coating and (stamping or dipping or roller or sponge or spraying)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:32
L18	1	(plastic adj component) and coating and (stamping or dipping or roller or sponge or spraying) and (prevent near2 solder)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:33
L19	0	(plastic adj component) with coating with (stamping or dipping or roller or sponge or spraying) with (prevent near2 solder)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:34
L20	8	(plastic adj component) with coating with (stamping or dipping or roller or sponge or spraying)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/26 16:35